



Product Change Notification / MFOL-16RWLS294

Date:

21-Jun-2022

Product Category:

Microprocessors

PCN Type:

Manufacturing Change

Notification Subject:

eSign# E000114850 Final Notice: Qualification of MCSO (Microchip -Fab 5) as a new fabrication site for Die # 2 of components DSC6003HI2B-024.0000T (Y2) and DSC6102HI2B-025.0000T (Y3) for modules ATSAMA5D27-WLSOM1 and ATSAMA5D27-WLSOM21 available in 188L Module (40.8x40.8x3.3mm) package assembled at MMT assembly site.

Affected CPNs:

[MFOL-16RWLS294_Affected_CPN_06212022.pdf](#)

[MFOL-16RWLS294_Affected_CPN_06212022.csv](#)

Notification Text:

PCN Status:Final Notification

PCN Type:Manufacturing Change

Microchip Parts Affected:Please open one of the files found in the Affected CPNs section.

Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:Qualification of MCSO (Microchip -Fab 5) as a new fabrication site for Die # 2 of components DSC6003HI2B-024.0000T (Y2) and DSC6102HI2B-025.0000T (Y3) for modules ATSAMA5D27-WLSOM1 and ATSAMA5D27-WLSOM21 available in 188L Module (40.8x40.8x3.3mm) package assembled at MMT assembly site.

Pre and Post Change Summary:

Method to Identify Change:Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History:June 21, 2022: Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

[PCN_MFOL-16RWLS294_PRE AND POST CHANGE SUMMARY.pdf](#)

[PCN_MFOL-16RWLS294_PACKAGE_QUAL_REPORT.pdf](#)

[PCN_MFOL-16RWLS294_PROCESS_QUAL_REPORT.pdf](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

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If you wish to change your PCN profile, including opt out, please go to the [PCN home page](#) select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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Affected Catalog Part Numbers (CPN)

ATSAMA5D27-WLSOM1

ATSAMA5D27-WLSOM21